Dynamic probe of atom exchange during monolayer growth

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In heteroepitaxy, impinging beam atoms can either wet the surface or swap with substrate atoms. Herein, we present a dynamic study of these phenomena throughout the assembly of the first atomic layer of Ge on Si(111). In situ spectromicroscopic analysis demonstrates that, at a sufficiently high temperature, atom exchange is more significant at the early stages of growth and attenuates as deposition proceeds. Our result highlights the role of propagating monolayer edges in the entropy-driven atom swapping and demonstrates that substitution of Si by Ge is a low-energy pathway to incorporate Ge in the growing monolayer. These observations are confirmed by molecular dynamics simulations.

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I. INTRODUCTION

The realization of hybrid structures with atomically sharp interfaces has been a formidable challenge in modern materials physics and nanoscience.1-4 The subject is fundamentally attractive due to the complexity of phenomena involved at the interface between dissimilar materials.4 From a technological standpoint, the nature and quality of epitaxial interfaces play crucial roles in shaping the properties of hybrid devices and define their functionality and reliability. For the technologically important Ge/Si system, gaining insight and control over the characteristics of the interface is of tremendous significance in the design and fabrication of high-performance electronic and photonic devices.6,7 It is well established that bulk diffusion (energy barrier of 4–5 eV, Ref. 8) is negligible under typical growth conditions due to kinetic constraints.9 This competition between Ge surface wetting and Ge-Si interface mixing is still missing. The chemical and morphological probes utilized so far involve growth interruptions and quenching11–13 and thus only convey a static description of the interface, which may not disclose its dynamic evolution. Moreover, growth interruption and surface cooling may alter the structural characteristics of the growing ML, as pointed out earlier.17 In this context, we present a dynamic study of Ge deposition on Si throughout the ML formation at low temperatures. Insights into the atomic processes governing the formation of the Ge/Si interface are obtained by dynamically monitoring both the morphology and composition of the growing ML. We found that the ML growth is nearly abrupt at 200 °C, that is, Ge-Si exchange is rather limited at this temperature. However, an increase in growth temperature up to 270 °C triggers intermixing. This phenomenon is more pronounced at the early stages of the growth of ML-high two-dimensional (2D) islands. By continuing Ge deposition, the extent of intermixing diminishes, and consequently, Ge content progressively increases until it reaches a steady regime. Our observations provide clear evidence for the role of the propagating island edges in atoms swapping across the interface and demonstrate that substitution of Si by Ge is a low-energy pathway to incorporate Ge in the growing one-atom-thick layer. These experimental observations are supported by molecular dynamics (MD) simulations.

II. EXPERIMENTAL DETAILS

Our experiments were carried out using the spectroscopic photoemission and low-energy electron microscope (SPELEEM) at the Nanospectroscopy beam line available at the Elettra synchrotron light source in Trieste. The microscope allows low-energy electron microscopy (LEEM) with a spatial resolution of ~10 nm and energy-filtered x-ray photoemission electron microscopy (XPEEM) with an energy resolution of ~0.25 eV. To enable in situ investigations of epitaxial
phenomena, the microscope is equipped with a solid-source molecular beam epitaxy system. The growth was performed by deposition of Ge on Si(111) substrates at a growth rate of \(3.47 \times 10^{12} \text{ atoms/(cm}^2 \text{ s)}\) (1.56 \(\times 10^{15} \text{ atoms/cm}^2\) correspond to 1 ML). Prior to Ge deposition, Si(111) substrates were subjected to extended degassing at 600 °C and then repeatedly heated up to \(\sim 1200 \degree C\) until a sharp \(1 \times 1 \rightarrow 7 \times 7\) transition was observed. By operating the SPELEEM microscope under the dispersive plane configuration, successive Si 2\(p\) and Ge 3\(d\) core-level spectra were dynamically acquired during Ge evaporation from areas of 3-μm diameter using a photon energy of 130 eV.

III. RESULTS AND DISCUSSION

In order to monitor the monolayer formation, LEEM investigations were performed and used as a reference for the dynamic micro x-ray photoelectron spectroscopy (\(\mu\)-XPS) analysis. Figure 1 displays a representative sequence of a LEEM movie recorded during the ML growth (for the complete movie see the Supplemental Material). The bright contrast corresponds to the ML-high 2D islands. Nucleation of a second layer was never observed in our LEEM data for \(\theta < 1\) ML.

The coalescence of 2D islands above \(\sim 0.5\) ML leads to the formation of large stripes, which propagate to cover the whole surface after deposition of 1 ML Ge. This growth behavior is independent of temperature in the range investigated in this work (200–270 °C). The morphological changes depicted in Fig. 1 agree well with earlier observations. Deposited Ge atoms, as well as displaced Si atoms, diffuse towards the islands steps, where they incorporate. However, as inferred below, the growth may involve more complex atomic pathways.

On samples identical to those investigated by LEEM, Si 2\(p\) and Ge 3\(d\) core-level spectra were recorded during Ge deposition until completion of the ML growth. Figure 2 displays the Si 2\(p\) and Ge 3\(d\) intensity maps measured throughout the ML assembly at 270 °C. Expectedly, the intensity of the Ge 3\(d\) peak progressively increases with Ge deposition, whereas the intensity of the Si 2\(p\) peak decreases due to the attenuation of the photoelectron signal by the growing layer. The theoretical XPS intensity can be calculated using the Berglund and Spicer treatment, which gives the intensity of the photoelectron flux from element \(\alpha\) perpendicular to the sample surface emitted from the volume element \(dV\) at a depth \(h\) as \(dI = I_0 N x_\alpha \sigma_\alpha e^{-h/\lambda_\alpha} dV\), where \(x_\alpha\), \(\sigma_\alpha\), and \(\lambda_\alpha\) are elemental concentration, photoemission cross section, and photoelectron escape depth, respectively. \(N\) is the atomic density, and \(I_0\) accounts for the x-ray intensity and photoelectron detection efficiency. Considering the general case of \(n\) SiGe intermixed layers (\(n \geq 1\)) on a Si substrate, the intensity of the Si 2\(p\) core level (\(I_{Si2p}\)) includes the contributions from Si atoms in these \(n\) layers; that from the
I takes place at the same rate in this regime. The interesting 200 and 270 experimental intensity ratios of core-level spectra acquired at 0.1) at the lowest growth temperature. This suggests that the abrupt growth ratio (defined as \( \delta R \)) at the lowest growth temperature. This suggests that the abrupt growth ratio (defined as \( \delta R \)).

\[
I_{Si2p}(\theta) = I_0 N \sigma_{Si} \lambda_{Si} \left\{ 1 - A(\theta) + A(\theta) e^{-nh/\lambda_{Si}} + \sum_{i=1}^{n} \lambda_i \left( e^{-(i-1)h/\lambda_{Si}} - e^{-ih/\lambda_{Si}} \right) \right\},
\]

where \( A(\theta) \) is the surface fraction covered by the ML-high 2D islands and \( h \) is the thickness of an atomic layer. \( x_i^{Ge} \) and \( x_i^{Si} \) denote the Ge and Si concentrations of layer \( i \), respectively. In the limit of an abrupt interface featuring a pure Ge ML on Si substrate (i.e., \( n = 1 \), \( x_1^{Ge} = 1 \), and \( x_1^{Si} = 0 \)), the corresponding intensity ratio \( I_{Ge3d}(\theta) \) is given by

\[
I_{Ge3d}(\theta) = I_0 N \sigma_{Ge} \lambda_{Ge} A(\theta) \sum_{i=1}^{n} \lambda_i \left( e^{-(i-1)h/\lambda_{Ge}} - e^{-ih/\lambda_{Ge}} \right).
\]

Figure 3(a) displays the evolution of \( \delta R \) as a function of \( \theta \) (solid line). \( A(\theta) \) is estimated from LEEM images. The experimental intensity ratios of core-level spectra acquired at 200 and 270 °C are also shown (dots). Independent of \( \theta \), \( \delta R \) differs significantly from the experimental data recorded at 270 °C. Here we ascribe this discrepancy to intermixing with Si substrate atoms. This intermixing is rather limited at 200 °C, as indicated by an intensity ratio very close to \( \delta R \). Note that the absence of a significant intermixing in earlier growth experiments performed at temperatures much higher than those used in this work is attributed to Bi being used as a marker in STM analysis.\(^\text{19}\) Indeed, Bi, which acts as a surfactant, floats on the top of the growing layer and suppresses the intermixing of Si and Ge.\(^\text{20}\) Figure 3(b) exhibits the evolution of the relative variation of the ratio of core-level intensities with respect to the abrupt growth ratio (defined as \( \delta R = \frac{R_{abrupt}(\theta) - R(\theta)}{R(\theta)} \)). Herein, \( \delta R \) provides a dynamic and semiquantitative measurement of the degree of exchange between substrate atoms and deposited atoms. It is noteworthy that \( \delta R \) is not sensitive to \( \theta \) (\( \delta R_{200 \text{ °C}} \sim 0.1 \)) at the lowest growth temperature. This suggests that the assembled 2D islands keep the same elemental composition throughout the growth. At 270 °C, \( \delta R \) evolves remarkably differently. First, it decreases monotonously at the early stage of the growth and then becomes practically unchanged (\( \sim 0.3 \)) for \( \theta \geq \sim 0.4 \text{ ML} \), indicating a stable composition of the growing 2D islands; that is, the incorporation of Si and Ge takes place at the same rate in this regime. The interesting fact here is, however, the gradual decrease in \( \delta R \), which is explained by a continuous increase in Ge content as the 2D islands grow larger for \( \theta \leq 0.4 \text{ ML} \).

The observations above suggest that intermixing progressively slows down as the growth proceeds. One may invoke two competing pathways of atomic mixing to explain these processes. First, in the low-coverge regime (\( \theta \leq 0.4 \text{ ML} \) at 270 °C), Ge deposition produces scattered 2D islands on the Si(111) surface (Fig. 1). These islands display a high rim-to-surface area ratio, which may promote substantial Si incorporation. Indeed, earlier reports have pointed out the critical role of step edges in Ge-Si intermixing.\(^\text{17,19}\) Thus it is reasonable to expect these 2D islands to contain a substantial amount of Si due to the exchange process promoted by the relative importance of the rim-to-surface ratio. Here, the fact that the atoms at the island edges have fewer nearest neighbors provides them with more steric freedom for an exchange process. As Ge coverage increases, the 2D islands enlarge and begin to coalesce (Fig. 1), thus forming larger islands with a lower rim-to-surface ratio and hence a smaller relative importance of Ge-Si exchanges at island edges. Second, the expanding fraction of surface covered implies an increasing probability for Ge atoms to be directly deposited onto these 2D islands. Here, the impinging Ge atoms can
incorporate into the growing 2D islands through trapping at step edges. Alternatively, following a displacive adsorption mechanism,\textsuperscript{27,28} Ge atoms deposited directly on the growing layer can remove Si and Ge atoms and occupy their sites. The displaced atoms can diffuse on the surface and possibly attach to step edges. In this latter scenario, only the substitution of Si atoms induces an increase in Ge content. To verify the consistency of these mechanisms, we investigated the evolution of the 2D islands by MD simulations.

MD simulations were performed using a $28.22 \times 23.04 \times 39.93 \text{Å}^3$ Si supercell and an improved bond-order potential (BOP4 + ).\textsuperscript{29} This potential is based on the tight-binding model and preserves the essential quantum-mechanical nature of atomic bonding. Calculations of atomic displacements, potential energy, stress, and temperature were done in 0.5-fs steps. The system was allowed to equilibrate, both geometrically and compositionally, before being subjected to annealing up to $\sim 270 ^\circ \text{C}$. During the cooling, the system relaxes through atomic displacements and volume changes. The simulated deposition of Ge atoms on a Si(111) surface demonstrates the nucleation of alloyed ML-high 2D islands with very negligible adsorption on bare Si (less than 1% of deposited atoms), and intermixing is found to be predominantly confined in the two topmost layers, in agreement with earlier observations.\textsuperscript{19} Here, the lower surface diffusivity and denser double-layer structure of Si(111) may be at the origin of this limited mixing as opposed to Si(100), where Ge can reach down to the fourth layer.\textsuperscript{12,18} Various configurations accounting for different Ge and Si distributions within the 2D islands were computed. Figure 4 displays a representative set of simulated configurations with $x^{\text{Ge}} \sim 0.5$. The analysis of the distribution of atoms and of the nature of interatomic bonds in the simulated configurations indicates that, within the range of a maximum of 1.3 of the equilibrium covalent bond distance of approximately Si-Si = 2.351 Å, Ge-Ge = 2.447 Å, and Si-Ge = 2.398 Å, all atoms have two atoms at the edge in the surface layer, three (surface-layer atoms far from the edge), or four (buried atoms) bonds. It is noteworthy that the measured bond length is characteristic for double bonds in nonfourfold bonding situations, which is indicative of surface reconstruction. For comparison, a 2D island was also simulated in the absence of relaxation [Fig. 4(a)]. At equilibrium, the calculated potential energy $E_{\text{POT}}$ in this case was estimated at $\sim -4.288 \text{eV/atom}$. To minimize the stress, a significant distortion of the lattice in surface and subsurface layers takes place during relaxation parallel to a rearrangement of surface layer atoms. This reduces $E_{\text{POT}}$ by $\sim 50-70 \text{meV/atom}$. An additional gain of $\sim 60-70 \text{meV/atom}$ is obtained after deposition and entrapment of a Ge atom at the edges. Figures 4(c) and 4(d) display the evolution of the 2D island after addition of a Ge atom. This atom displaces an existing Si atom, which was allowed to freely diffuse on the surface. For all investigated configurations, we observed two distinct scenarios with the displaced Si atom either diffusing away or attaching to the 2D island step edges. In this latter case, $E_{\text{POT}}$ drops by $\sim 7$ to $\sim 16 \text{meV/atom}$. Instead, the decrease is only $\sim 6$ to $\sim 8 \text{meV/atom}$ when the displaced Si atom diffuses away. In both cases the decrease of $E_{\text{POT}}$ indicates that the substitution of Si by newly deposited Ge is a low-energy pathway for the Ge enrichment of the growing alloyed ML, which supports the mechanisms proposed above.

IV. CONCLUSION

In conclusion, we have presented a dynamic probe of atomic mixing throughout the assembly of a single ML during the epitaxy of Ge on Si(111). We developed an analytical model to assess the exchange between substrate atoms and deposited atoms in a one-atomic-layer-thick 2D island during their assembly and coalescence. Intermixing with substrate atoms was found to be sensitive to substrate temperature. At 200 °C, the deposited atoms were found to predominantly wet the surface, whereas at 270 °C the intermixing is stronger especially at the early growth stages. By continuing Ge deposition at this temperature, Ge surface content progressively increases parallel to lateral growth of 2D islands to form one atomic layer. Our observations provide evidence for the role of the propagating 2D island edges in the entropy-driven atomic swapping, whereas the expanding terraces resulting from coalescence of fragmented 2D islands become favorable sites for Ge incorporation.

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See Supplemental Material at http://link.aps.org/supplemental/10.1103/PhysRevB.85.201416 for the complete LEEM movie of Fig. 1.


